



DOCKET NO.: 4597

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
IN THE MATTER OF THE PATENT APPLICATION

OF: Hiroshi URAGAMI et al. | Art Unit: 2823  
USSN: 10/719,379 | Ex.: Brook KEBEDE  
FILED: November 20, 2003 | Conf. No.: 2559

FOR: Method of Resin Encapsulation,  
Apparatus for Resin Encapsulation,  
Method of Manufacturing Semiconductor Device,  
Semiconductor Device and Resin Material

MS AMENDMENT  
COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450

May 24, 2005

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. 1.97(c)(1) WITH  
CERTIFICATE OF MAILING ON LAST PAGE

Dear Sir:

- 1) This is **NOT** a response to the Office Action of April 29, 2005. A Response will be filed in due course.
- 2) Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98 applicants are enclosing a Form PTO-1449, copies of cited references AE and AF, an English abstract of reference AE, and a copy and an English version of a German Search Report issued in a counterpart German Application on April 13, 2005.
- 3) In compliance with 37 C.F.R. §1.97(c) this Information Disclosure Statement is being filed before the mailing date of a Final Office Action or Notice of Allowance and includes a statement under 37 CFR 1.97(e) (see next paragraph). Thus **no fee is due**.

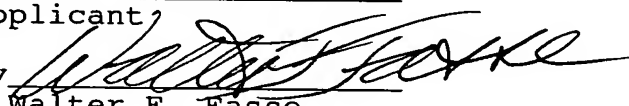
- 4) The undersigned hereby certifies that each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.
- 5) References AA to AD are in English. Reference AE is accompanied by an English abstract and corresponds to AA, from which its relevance can be determined in English. No further discussion of the references is necessary.
- 6) Moreover, the enclosed Search Report indicates the degree of relevance of references AB to AF by category (Y = relevant for obviousness when combined with another document; and A = technological background, general state of art). Thereby, a concise explanation of the relevance has been provided (see M.P.E.P. §609).
- 7) The Examiner is respectfully requested to consider all references of record, return an initialed copy of the enclosed Form PTO-1449 and ensure that all references of record are printed on any patent issuing from this application.

Respectfully submitted,

Hiroshi URAGAMI et al.

Applicant,

By

  
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WFF:hc/4597

Encls.: postcard,

Form PTO-1449,

copy of German Search Report,

English version of German

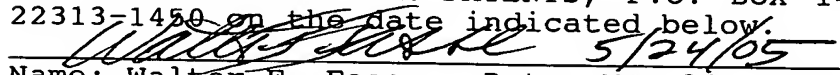
Search Report,

2 references,

1 English abstract

CERTIFICATE OF MAILING:

I hereby certify that this correspondence with all indicated enclosures is being deposited with the U. S. Postal Service with sufficient postage as first-class mail, in an envelope addressed to: COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450 on the date indicated below.

  
Name: Walter F. Fasse - Date: May 24, 2005

Sheet 1 of 1  
**FIRST IDS LIST OF REFERENCES  
 CITED BY APPLICANT**  
 (FORM PTO-1449)  
 DATED: May 24, 2005

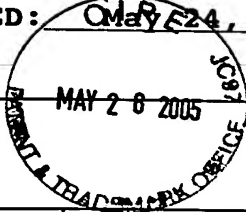
Atty. Docket No.  
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 10/719,379

Applicant: Hiroshi URAGAMI et al.

U.S. Filing Date:  
 November 20, 2003

Art Unit:  
 2823



**U. S. PATENT DOCUMENTS**

*EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	Cl.	Sub- Cl.	Fil. Date
	AA	5,123,823	06/1992	Banjo et al.	-	-	-
	AB	5,435,953	07/1995	Osada et al.	-	-	-
	AC	6,187,243	02/2001	Miyajima	-	-	-
	AD	2001/0008775	07/2001	Yamamoto	-	-	-

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NO.	DATE	COUNTRY	Cl.	Sub- Cl.	Trans.	
							Yes	No
	AE	41 02 934	08/1991	Germany	-	-	=AA & Abst	
	AF	1 035 572	09/2000	Europe	-	-	Engl.	

**OTHER DOCUMENTS**

EXAMINER'S SIGNATURE		DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.